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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/620,523	07/20/2000	Bruce E. Novich	1596C5	2899
22852 7590 07/31/2007 FINNEGAN, HENDERSON, FARABOW, GARRETT & DUNNER LLP			EXAMINER	
			GRAY, JILL M	
901 NEW YORK AVENUE, NW WASHINGTON, DC 20001-4413			ART UNIT	PAPER NUMBER
			1774	
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			07/31/2007	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)			
	09/620,523	NOVICH ET AL.			
Office Action Summary	Examiner	Art Unit			
	Jill M. Gray	1774			
The MAILING DATE of this communication app	ears on the cover sheet with the c	orrespondence address			
Period for Reply  A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA  - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication.  - If NO period for reply is specified above, the maximum statutory period w  - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be time will apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).			
Status					
<ol> <li>Responsive to communication(s) filed on 15 M</li> <li>This action is FINAL.</li> <li>Since this application is in condition for alloward closed in accordance with the practice under E</li> </ol>	action is non-final.  nce except for formal matters, pro				
Disposition of Claims					
<ul> <li>4)  Claim(s) 1,4,6-40 and 43-58 is/are pending in the 4a) Of the above claim(s) 4,6-11,21-39 and 48-5)  Claim(s) is/are allowed.</li> <li>6)  Claim(s) 1,12-20,40 and 43-47 is/are rejected.</li> <li>7)  Claim(s) is/are objected to.</li> <li>8) Claim(s) are subject to restriction and/or</li> </ul>	<u>58</u> is/are withdrawn from conside	ration.			
Application Papers					
9) The specification is objected to by the Examiner 10) The drawing(s) filed on is/are: a) access Applicant may not request that any objection to the of Replacement drawing sheet(s) including the correction of the oath or declaration is objected to by the Examiner	epted or b) objected to by the Edrawing(s) be held in abeyance. See ion is required if the drawing(s) is obj	e 37 CFR 1.85(a). ected to. See 37 CFR 1.121(d).			
Priority under 35 U.S.C. § 119					
12) Acknowledgment is made of a claim for foreign  a) All b) Some * c) None of:  1. Certified copies of the priority documents  2. Certified copies of the priority documents  3. Copies of the certified copies of the prior  application from the International Bureau  * See the etterhal detailed Office action for a list.	s have been received. s have been received in Application ity documents have been receive (PCT Rule 17.2(a)).	on No ed in this National Stage			
* See the attached detailed Office action for a list of the certified copies not received.					
Attachment(s)					
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal Pa 6) Other:	te			

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#### **DETAILED ACTION**

### Response to Amendment

The rejection of claims 1, 3, 5, and 17 under 35 U.S.C. 102 (b) as being anticipated by Singer et al., 3,615,303 is moot in view of applicants' amendments.

The rejection of claims 18 and 47 under 35 U.S.C. 112 second paragraph is moot in view of applicants' amendments.

## Claim Rejections - 35 USC § 103

- 1. The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.
- 2. Claims 1, 12-20, 40, and 43-47 are rejected under 35 U.S.C. 103(a) as being unpatentable over Japanese Patent Publication translation, 4-307787 (Iketani) in view of Japanese Patent Publication translation 1-249333 (Nagamina) as applied in the previous Office Action, and further in view of PCT Publication WO 93/24314 (Papageorge).

Iketani teaches a method for manufacturing a printed circuit substrate by inserting a glass cloth prepeg impregnated with a thermosetting resin varnish. See abstract. In addition Iketani teaches that the prepeg is obtained by impregnating the fiber substrate with a varnish containing a filler and then impregnating with a varnish containing no filler, per claims 1 and 40. The substrate can be glass cloths and nonwoven glass fabrics and the fillers can be inorganic non-polymeric fillers. The filler has a particle size within the instant claimed range, per claims 15 and 44. See [0006]. Also, the thermosetting varnish can be an epoxy resin, polyamide resin or a phenolic

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resin, wherein the preferred resin is an epoxy resin. See [0007]. Accordingly, Iketani teaches that the glass cloth is impregnated with a "resin compatible coating" which is compatible with the matrix material, and that said "resin compatible coating" comprises a plurality of particles, as required by claims 1 and 40. While Iketani teaches that glass cloths can be used he is silent as to the glass cloth being non-degreased and the specific particles as now claimed.

Papageorge teaches printed circuit boards comprising a laminate formed by impregnating a resin, such as epoxy into a glass cloth substrate wherein the base resin has highly thermally conductive particles incorporated therein, wherein said particles can be a nitride, carbide or graphite. See pages 4-5 and Examples. At the time the invention was made, the skilled artisan would have been reasonably motivated to modify the teachings of Iketani by using as the filler material a nitride, carbide or graphite, as taught by Papageorge in order to produce a laminate with high thermal conductivity, by incorporating filler material of high thermoconductivity, low coefficient of thermal expansion and sufficient hardness. Accordingly, the substitution of one known filler material in the production of reinforced laminates for another (known filler material) would have yielded predictable results to one of ordinary skill in the art at the time of the invention.

Nagamina is as set forth previously and teaches a laminate adapted for an electronic support wherein the laminate comprises a glass cloth impregnated with a resin such as epoxy. Nagamina teaches that the glass yarns that his glass cloth is formed from can be sized with various known sizing agents which can be used in

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accordance with the purpose of the glass cloth. Nagamina also discloses that a non-desizing sizing agent, which does not require degreasing or surface treatment is known in the art, said non-desizing sizing agent eliminating the necessity of twisting, degreasing, and surface treatment and thereby significantly improving productivity and production yield.

As set forth above, Iketani teaches circuit board substrate comprising a glass cloth prepeg impregnated with a thermosetting varnish containing a filler and a varnish without a filler. Iketani is silent as to whether the glass cloth is non-degreased. Also as set forth above, Nagamina teaches that non-desized glass cloths are known in the art and provide efficacious economic properties such as improved productivity and production yield. It would have been obvious to one of ordinary skill in the art at the time the invention was made to use as the glass cloth substrate any glass cloth substrates known in the art as being suitable for impregnation of epoxy resins when producing substrates for circuit boards such as a non-desized glass cloth as taught by Nagamina, motivated by the reasonable expectation of success of making a prepeg for a circuit board substrate and improving productivity and production yield. In addition, all of the claimed elements were known in the art, namely, sized glass cloths and nondesized glass cloths, both of which are taught to be useful in the production of laminates for electronic supports. The substitution of one known element (sized glass cloth) for another known in the art, (non-desized glass cloth) would have yielded predictable results to one of ordinary skill in the art at the time the invention was made.

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As to claim 13, Papageorge teaches that the particles can be nitrides, carbides or graphite, which are the same type of particles contemplated by applicants. Accordingly, it is the position of the examiner that the particles of the prior art have a Moh's hardness value which does not exceed the Moh's hardness value of glass fiber.

As to claims 14 and 43, Iketani teaches that the particles have a particle size within applicants' claimed range. Accordingly, it is the examiner's position that the teachings of Iketani would have provided direction to the skilled artisan for particles of the instant claimed size and thereby obviating the requirement of a particle size sufficient to allow strand wet out.

As to claims 16-17, 19-20, and 45-46, Iketani is silent as to the specific composition of the resin compatible coating; however, Iketani does teach that epoxy with fillers can be the thermosetting impregnating varnish. Nagamina teaches an epoxy resin for a use in as an impregnating varnish for glass cloth in the formation of circuit boards, said epoxy resin comprising at least one film-forming material, a resin reactive diluent comprising functional groups of the type contemplated by applicants. Note page 17. At the time of the invention thereof, it would have been obvious to the skilled artisan, to impregnate a glass cloth substrate with an epoxy resin composition containing particulate filler, as taught by Iketani, wherein the specific filler material and epoxy resin composition are selected from among those known in the art, such as those filler materials taught by Papageorge and the epoxy resin composition taught by Nagamina and as set forth by applicants, motivated by the ability to produce laminates

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for electronic supports that have good dimensional stability, dielectric properties and heat resistance.

Regarding claim 12, Papageorge teaches filler material that is the same type contemplated by applicants, such as graphite, nitrides and carbides. Accordingly, the examiner has reason to believe that filler material of Papageorge have a thermal conductivity within the instant claimed range, in the absence of factual evidence to the contrary.

Regarding claims 18 and 47, the reinforced laminate of the prior art is substantially similar to that of applicants. Accordingly, it is the position of the examiner that properties such as LOI and air permeability are the same as well, in the absence of factual evidence to the contrary.

Therefore, the combined teachings of Iketani, Nagamina and Papageorge would have rendered obvious the invention as claimed in present claims 1, 12-17, 19-20, 40, and 43-46.

3. Claims 1, 12-13, 16-20, 40 and 45-47 are rejected under 35 U.S.C. 103(a) as being unpatentable over PCT Publication WO 93/24314 (Papageorge) in view of Japanese Patent Publication translation 1-249333 (Nagamina), each as applied above.

Papageorge is as set forth above but is silent as to the glass cloth being nondegreased.

Nagamina is as set forth previously and teaches a laminate adapted for an electronic support wherein the laminate comprises a glass cloth impregnated with a resin such as epoxy. Nagamina teaches that the glass yarns that his glass cloth is

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formed from can be sized with various known sizing agents, which can be used in accordance with the purpose of the glass cloth. Nagamina also discloses that a non-desizing sizing agent, which does not require degreasing or surface treatment is known in the art, said non-desizing sizing agent eliminating the necessity of twisting, degreasing, and surface treatment and thereby significantly improving productivity and production yield.

As set forth above, Papageorge teaches laminates for circuit board comprising a glass cloth prepeg impregnated with a thermosetting resin containing a filler. Papageorge is silent as to whether the glass cloth is non-degreased. Also as set forth above, Nagamina teaches that non-desized glass cloths are known in the art and provide efficacious economic properties such as improved productivity and production yield. It would have been obvious to one of ordinary skill in the art at the time the invention was made to use as the glass cloth substrate any glass cloth substrates known in the art as being suitable for impregnation of epoxy resins when producing substrates for circuit boards such as a non-desized glass cloth as taught by Nagamina, motivated by the reasonable expectation of success of making a laminate for a circuit board substrate and improving productivity and production yield. In addition, all of the claimed elements were known in the art, namely, sized glass cloths and non-desized glass cloths, both of which are taught to be useful in the production of laminates for electronic supports. The substitution of one known element (glass cloth) for another known in the art, (non-desized glass cloth) would have yielded predictable results to one of ordinary skill in the art at the time the invention was made.

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Regarding claim 12, Papageorge teaches filler material that is the same type contemplated by applicants, such as graphite, nitrides and carbides. Accordingly, the examiner has reason to believe that the filler material of Papageorge has a thermal conductivity within the instant claimed range, in the absence of factual evidence to the contrary.

As to claim 13, Papageorge teaches that the particles can be nitrides, carbides or graphite, which are the same type of particles contemplated by applicants. Accordingly, it is the position of the examiner that the particles of the prior art have a Moh's hardness value which does not exceed the Moh's hardness value of glass fiber.

As to claims 16-17, 19-20, and 45-46, Papageorge is silent as to the specific composition of the resin compatible coating; however, Papageorge does teach that epoxy with fillers can be the thermosetting impregnating resin. Nagamina teaches an epoxy resin for a use in as an impregnating varnish for glass cloth in the formation of circuit boards, said epoxy resin comprising at least one film-forming material, a resin reactive diluent comprising functional groups of the type contemplated by applicants. Note page 17. At the time of the invention thereof, it would have been obvious to the skilled artisan, to impregnate a glass cloth substrate with an epoxy resin composition containing particulate filler, as taught by Papageorge, wherein the specific filler material and epoxy resin composition are selected from among those known in the art, such as those filler materials taught by Papageorge and the epoxy resin composition taught by Nagamina and as set forth by applicants, motivated by the ability to produce laminates

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for electronic supports that have good dimensional stability, dielectric properties and heat resistance.

Regarding claims 18 and 47, the reinforced laminate of the prior art is substantially similar to that of applicants. Accordingly, it is the position of the examiner that properties such as LOI and air permeability are the same as well, in the absence of factual evidence to the contrary.

Therefore, the combined teachings of Papageorge and Nagamina would have rendered obvious the invention as claimed in present claims 1, 12-13, 16-20, 40, and 45-47.

No claims are allowed.

## Response to Arguments

4. Applicant's arguments with respect to claims 1, 12-20, 40, 43-47 have been considered but are most in view of the new ground(s) of rejection.

#### Conclusion

5. Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the

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shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jill M. Gray whose telephone number is 571-272-1524. The examiner can normally be reached on M-Th and alternate Fridays 10:30-7:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Milton I. Cano can be reached on 571-272-1398. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Primary Examiner

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